

# 专业PCB打样工厂,24小时加急出货 HT2860 6-Sound Generator

#### Features

- Single power supply: 2.4V~4.5V
- Low standby current: 1µA (Typ.) at VDD=3V
- Auto power-off function
- Six different sound sections

#### **General Description**



The HT2860 is a CMOS LSI chip designed for use in sound effect products. It can generate six sections of programmable sounds. The LSI is equipped with tone circuit and control logic to generate various sounds including door bell, alarm, melodies, etc. Users can play not only sound sections (S1~S6) by triggering a single key (K1~K6), but serial sound sections by si-

# K1 to K6 independently chosen or as Speaker or direct piezo application

- 0.5Hz~1Hz LED flash output
- Minimal external components

multaneously triggering more than one key according to the key priority where K1 is the highest and K6 is the lowest. The customer's sound sample is analyzed and programmed into an internal ROM by changing a mask layer during device fabrication. The HT2860 is suitable for various toy applications.

## **Pin Assignment**

	1	0	16	osc3	
KEY6	2		15	TEST3	
KEY5	3		14	🗆 OSC1	
KEY4	4		13	□ osc2	
KEY3 🗆	5		12		
KEY2 🗆	6		11	🗆 Ουτ	
KEY1 🗆	7		10		
vss 🗆	8		9	🗆 PWR	
HT2860					

- 16 DIP

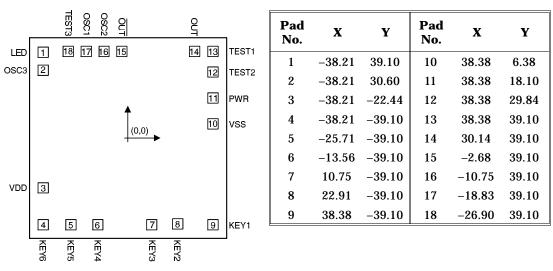
osc2 🗆	1	18			
OSC1 🗆	2	17	🗆 ОИТ		
TEST3 🗆	3	16			
LED 🗆	4	15			
OSC3 🗆	5	14	D PWR		
	6	13	□vss		
KEY6 🗆	7	12			
KEY5 🗆	8	11			
KEY4 🗖	9	10			
HT2860 - 18 DIP					





HT2860

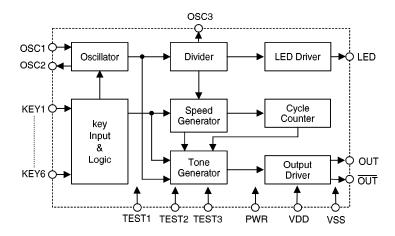
**Pad Coordinates** 



Chip size:  $89\times90\mbox{ (mil)}^2$ 

\* The IC substrate should be connected to VDD in the PCB layout artwork.

#### **Block Diagram**





#### **Pad Description**

Pad No.	Pad Name	I/O	Internal Connection	Description
1	LED	0	Inverter Out	LED flash output
2	OSC3	0	—	Vibration oscillator output
3	VDD	_	—	Positive power supply
4	KEY6	Ι	Pull-Low	KEY6 input, high active
5	KEY5	Ι	Pull-Low	KEY5 input, high active
6	KEY4	Ι	Pull-Low	KEY4 input, high active
7	KEY3	Ι	Pull-Low	KEY3 input, high active
8	KEY2	Ι	Pull-Low	KEY2 input, high active
9	KEY1	Ι	Pull-Low	KEY1 input, high active
10	VSS	_	_	Negative power supply, GND
11	PWR	Ι	—	Power on reset
12	TEST2	I/O		For IC test only
13	TEST1	I/O	_	For IC test only
14	OUT	0	Inverter Out	Sound output, normally low at the standby state
15	OUT	0	Inverter Out	Sound output, out of phase to pad 14
16	OSC2	0	_	Oscillator output
17	OSC1	Ι	_	Oscillator input
18	TEST3	I/O	—	For IC test only

#### **Absolute Maximum Ratings\***

Supply Voltage	–0.3V to 5V
Input Voltage	$V_{\rm SS}$ –0.3 to $V_{\rm DD}$ +0.3V

Storage Temperature......-50°C to 125°C Operating Temperature......0°C to 70°C

\*Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damageto the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### HT2860

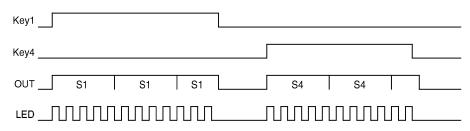
(Ta=25°C)

#### **Electrical Characteristics**

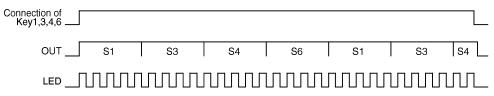
Symbol	Parameter	Те	<b>Test Conditions</b>		<b>T</b>	More	T
	Farameter	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Operating Voltage	_	_	2.4	3	4.5	V
ISTB	Standby Current	3V	_	_	1	5	μΑ
I <sub>DD</sub>	Operating Current	3V	No load		100	200	μA
I <sub>OH</sub>	OUT Source Current	3V	V <sub>OH</sub> =2.5V	-1	-2	_	mA
Iol	OUT Sink Current	3V	Vol=0.5V	1	2	_	mA
ILED	LED Source Current	3V	V <sub>OH</sub> =2.5V	-0.7	-1.5	_	mA
f <sub>SYS</sub>	Oscillator Frequency	3V	$R_{OSC}=120k\Omega$	_	128		kHz
V <sub>IH</sub>	"H" Input Voltage	3V	_	2.4	_		V
VIL	"L" Input Voltage	3V	_	_	_	0.6	V

#### **Timing Diagram**

#### Key1~Key6 Independent output



#### Key1~Key6 Cascade output



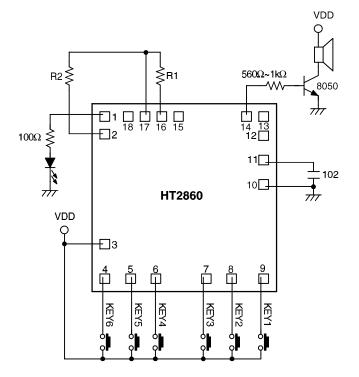
4



# **Application Circuits**

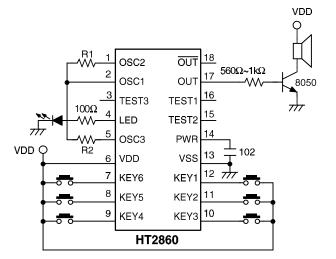
#### Speaker application

Chip form



\* The IC substrate should be connected to VDD in the PCB layout artwork.

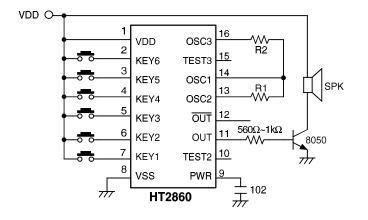
• 18-Pin DIP



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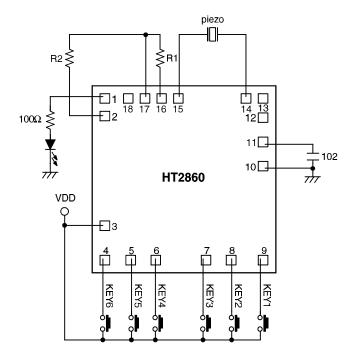


• 16-Pin DIP



### **Piezo application**

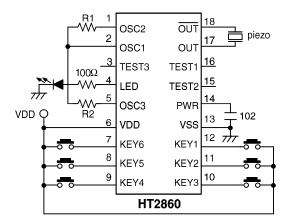
Chip form



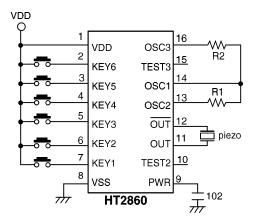
\* The IC substrate should be connected to VDD in the PCB layout artwork.



• 18-Pin DIP



• 16-Pin DIP



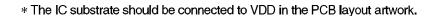
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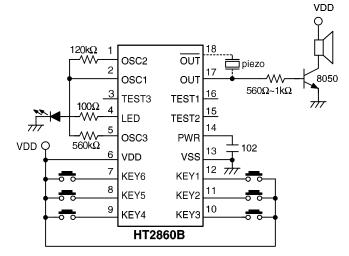
#### VDD Ο 120k $\Omega$ piezo 560Ω~1kΩ ≩ 560k $\Omega$ ≶ -0-8050 -~~~ $\frac{1}{2}$ <u>|</u> 15 -⊡1 -⊡2 □ 14 13 12 11 10 HT2860B VDD Q <del>-</del>]3 ₫ ф Å ф p KEY3 Ē KEY2 KEY5 KEY4 KEY6

# Application Circuits (HT2860B — Six Alarm Sounds)

• Chip form



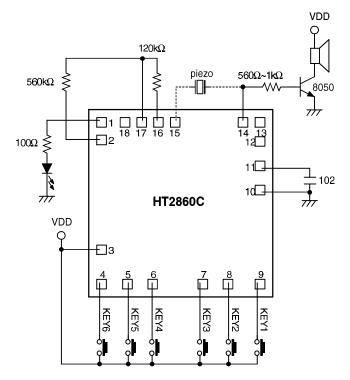
• 18-Pin DIP





## Application Circuits (HT2860C — Six Alarm Sounds)

Chip form



\* The IC substrate should be connected to VDD in the PCB layout artwork.

